

LINEAR TECHNOLOGY MATERIALS DECLARATION

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(Engineering Calculation)

TO-220

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TOTAL MASS (g) : 2.022421

| COMPONENT MATERIAL | VENDOR/ INDUSTRY NAMES | CONSTITUENT NAME | CAS NUMBER | CONSTITUENT MASS (g) | CONSTITUENT (PPM) OF MATERIAL | CONSTITUENT (PPM) OF TOTAL PKG. | | |
|--------------------------|---------------------------------|--------------------------------|------------|----------------------|-------------------------------|---------------------------------|----------------|----------------------|
| Active Device | Linear Technology | Silicon (Si) | 7440-21-3 | 0.005059 | 1000000 | 2501.45703125 | | |
| Die Coat | Dow Corning | Silicone | 69430-27-9 | 0.000000 | 0 | 0 | | |
| Lead Frame | Cu | Copper (Cu) | 7440-50-8 | 1.457910 | 998500 | 720873.5 | | |
| | | Iron (Fe) | 7439-89-6 | 0.000000 | 0 | 0 | | |
| | | Phosphorus (P) | 7723-14-0 | 0.000000 | 0 | 0 | | |
| | | Zinc (Zn) | 7440-66-6 | 0.000000 | 0 | 0 | | |
| | | Nickel (Ni) | 7440-02-0 | 0.000000 | 0 | 0 | | |
| | | Silicon (Si) | 7440-21-3 | 0.000000 | 0 | 0 | | |
| | | Magnesium (Mg) | 7439-95-4 | 0.000000 | 0 | 0 | | |
| | | Tin (Sn) | 7440-31-5 | 0.002190 | 1500 | 1082.86035156 | | |
| Lead Frame Total: | | | | 1.460100 | 1000000 | 721956.4375 | | |
| Plating | PMI | Exter. Plating Pb | 7439-92-1 | 0.000000 | 0 | 0 | | |
| | | Exter. Plating Sn | 7440-31-5 | 0.012534 | 1000000 | 6197.67431641 | | |
| | | External Plating Total: | | | | 0.012534 | 1000000 | 6197.67431641 |
| | | Inter. Plating Ni | 7440-02-0 | 0.017000 | 893796 | 8405.76660156 | | |
| | | Inter. Plating Ag | 7440-22-4 | 0.002020 | 106203.992188 | 998.802734375 | | |
| | | Internal Plating Total: | | | | 0.019020 | 1000000 | 9404.56933594 |
| Die Attach | 95Pb / 5 Sn | Silver (Ag) | 7440-22-4 | 0.000000 | 0 | 0 | | |
| | | Tin (Sn) | 7440-31-5 | 0.000117 | 50000 | 57.8514480591 | | |
| | | Lead (Pb) | 7439-92-1 | 0.002226 | 950000 | 1100.6607666 | | |
| | | Silica (SiO2) | 60676-86-0 | 0.000000 | 0 | 0 | | |
| | | Indium (In) | 7440-74-6 | 0.000000 | 0 | 0 | | |
| | | Metal Oxide | | 0.000000 | 0 | 0 | | |
| | | Antimony (Sb) | 7440-36-0 | 0.000000 | 0 | 0 | | |
| | | Resin (EP) | | 0.000000 | 0 | 0 | | |
| Die Attach Total: | | | | 0.002343 | 1000000 | 1158.51220703 | | |
| Encapsulation | MULTI-AROMATIC RESIN Br/Sb FREE | Resin (EP) | | 0.053828 | 103000 | 26615.6210938 | | |
| | | Bromine (Br) | 40039-93-8 | 0.000000 | 0 | 0 | | |
| | | Silica (SiO2) | 60676-86-0 | 0.467727 | 895000 | 231270.8125 | | |
| | | Antimony Trioxide (Sb2O3) | 1309-64-4 | 0.000000 | 0 | 0 | | |
| | | Metal Hydroxide | | 0.000000 | 0 | 0 | | |
| | | Carbon Black (C) | 1333-86-4 | 0.001045 | 2000 | 516.707397461 | | |
| | | Encapsulation Total: | | | | 0.522600 | 1000000 | 258403.125 |
| Bond Wire Estimated | AFW/TANAKA/ Kn | Gold (Au) | 7440-57-5 | 0.000765 | 1000000 | 378.259460449 | | |
| | | | | | TOTAL MASS (g) : | 2.022421 | | |